## **Tyrone Camarero Specifications**

## Camarero SDI100A3TB-23

## **Key features**

Hyperconverged Infrastructure, Container Storage,Scale-Out File Server Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following

- Socket P+ (LGA 4189) support 3rd Gen Intel Xeon<sup>®</sup> Scalable processors
- Intel® C621A
- 20 DIMM Slots (16 DIMM Slots + 4 Intel® Optane™ Persistent Memory Slots)
- 2 PCI-E 4.0 x16 (LP) slot; Tool-less support Internal PCI-E 3.0 x8 for 2 M.2 NVMe/SATA support onboard Optional NVMe Boot Controller via AOC-SMG3-2M2-B
- Network connectivity via AIOM (OCP 3.0 compliant)
- 3 Hot-swap 3.5" drive bays; 3 PCI-E 4.0 NVMe/SATA 3.5" drives
  4 cooling fans per 211 enclosure 14 9K PPM: Shared Cooling Decision and Cooling Decision
- 4 cooling fans per 2U enclosure, 14.9K RPM; Shared Cooling Design Liquid Cooling Support
- 2600W Redundant Power Supplies Titanium Level (96%+); Shared Power Design

Processor/Cac	he
Processor	Dual Socket P+ (LGA 4189),3rd Gen Intel® Xeon® Scalable processors,Support CPU TDP 185W,32C/64T,Certain CPUs with high TDP may be supported only under specific conditions. Please contact Tyrone Technical Support for additional information about specialized system optimization
Chipset	
Chipset	Intel® C621A chipset
System Memor	у
Memory Capacity	16 DIMM slots (16 DRAM + 4 PMem), UP to 4TB: 16x 256 GB DRAM, UP to 6TB: 8x 256 GB DRAM and 8x 512 GB PMem Memory Type: 3200MHz ECC DDR4 RDIMM, Intel® Optane™ persistent memory 200 series
Expansion Slot	S
PCI-Express	Slot 1: PCI-E 4.0 x16 LP Slot 2: PCI-E 4.0 x16 LP Internal Slot: M.2
ntegrated O	nboard
ΙΡΜΙ	Support for Intelligent Platform Management Interface v.2.0 IPMI 2.0 with virtual media over LAN and KVM-over-LAN support
Add-on Opti	ons
Raid Card Optical Drive	None





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Front Panel		
LEDs	HDD activity LED Network activity LEDs Power status LED Universal Information (UID) LED	
Buttons	Power On/Off button, UID button	
Drive Bays		
HDD Bays	3x 3.5"" hot-swap NVMe/SATA drive bays (3x 2.5"" NVMe hybrid; 3x 3.5"" NVMe hybrid M.2 2 M.2 NVMe OR 2 M.2 SATA3	
Power Supply		
2600W Redu Shared Powe	ndant Power Supplies Titanium Level (96%+); r Design	
Cooling System		
_	is per 2U enclosure, 14.9K RPM; Shared gn Liquid Cooling Support	
Form Factor		
Form Factor	2U Rackmount	
Dimensions:	Height :3.47" (88mm), Width :17.68" (449mm ), Depth : 30.5" (774mm)	
En	nail : info@tyronesystems.com	
For more/	current product information, visit	
- 1 - N	www.tyronesystems.com	

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